



#14/18 8/1/03

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Justin B. Rand, Reg. No. 48,552

Name of applicant, assignee or  
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*Justin B. Rand*

Signature

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GROUP 1700

Our Case No. 10541/279  
Visteon Case No. V200-0303

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

Peter J. Sinkunas, et al.

Serial No. 09/820,092

Filing Date: March 28, 2001

For FLEX TO FLEX SOLDERING BY  
DIODE LASER

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)  
) Examiner: Colleen P. Cooke  
)  
) Group Art Unit No. 1725  
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)  
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Assistant Director of Patents  
Washington, D.C. 20231

**AMENDMENT**

Dear Sir:

In response to the outstanding Office Action mailed April 24, 2003, Applicants  
submit the following.